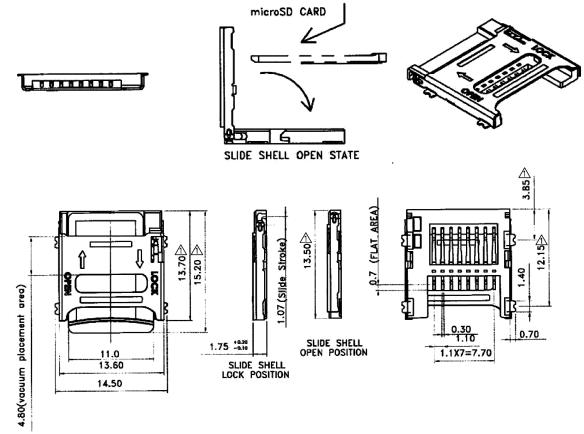
Micro SD Memory Card Connector multicomp



Specifications: Material

RoHS Compliant

Material		
Insulator	: Liquid Crystal Polymer	
Contacts	: Phosphor Bronze	
Shell	: Stainless Steel (SUS301)	
Contact Plating		
Under plate	: 50µ" to 100µ" Nickel	
Contact area	: 1µ" Gold	
Solder tails area	: 1µ" Gold	
Electrical		
Rate Voltage	: 10V (Max.)	
Current Rating	: 0.5 Amps (Max.)	
Contact Resistance	: $80m\Omega$ initial (Final $100m\Omega$)	
Insulation resistance	: 1,000MΩ min. @ 500V DC	
Dielectric withstanding Voltage	: 500V AC / 1 minute	
Temperature Range	: -25°C to +85°C	
Mating Cycles	: 10,000 insertions	

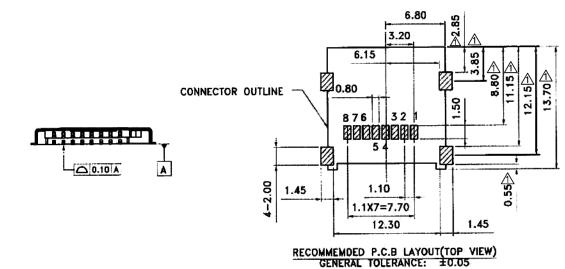


Dimensions : Millimetres

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Dimensions : Millimetres

Pin Assignment Table

Pin Number	Name
1	DAT2
2	CD / DAT3
3	CMD
4	VDD
5	CLK
6	VSS
7	DAT0
8	DAT1

Part Number Table

Description	Part Number
Micro SD Memory Card Connector	460DE08C3

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